Test beam results of the CMS 2S P₋-module prototypes using the CBC2 read-out chip.

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CMS Phase-II Tracker Upgrade for the HL-LHC The CMS Binary Chip The 2S Module Design

Upgrade Motivation

For the High Luminosity LHC (HL-LHC) a major upgrade is planed for the CMS experiment. In its Phase-II, the accelerator will reach luminosities up to 5×10^{34} cm⁻² s⁻¹. To cope with the increased rates and occupancies, CMS will replace the current tracker with an entirely new system, which must be able to withstand the increased radiation corresponding to 3000 fb⁻¹ integrated luminosity and resolve up to 140 collisions per bunch crossing while being able to provide information to the first level trigger (L1) and maintain the excellent tracking performance.



Map of the sensor spacing adopted in the Tracker. The sensor spacing is optimized at the same time as the acceptance window using tkLayout, to obtain a P_{τ} threshold of 2 GeV for the stub selection in all module locations. The optimal acceptance window is then recalculated and fine-tuned using the Monte Carlo simulation [1].



The CBC2[2] is a 130 nm CMOS readout chip. It has 254 input channels (127 per sensor) and is designed to provide an on-board L1 trigger using stub-finding logic for high- P_{τ} track identification.



The Phase-II Outer Tracker Detector

The outer tracker consists of two types of P_{τ} -modules, which are capable of rejecting signals from particles below a certain P_{τ} threshold. The PS (7084) modules composed of closely-spaced silicon pixel and strip sensors, and the 2S (8424) modules with two closelyspaced strip sensors. The stacked sensors in each module are read out with a common chip which correlates signals, for the L1 trigger, that pass the P_{τ} threshold, which are called stubs.



Number of hits (left) and radiation length (right) versus η for the Phase-II Tracker and the Phase-I Tracker. The radiation length distribution is shown for the tracking acceptance of the Phase-I Tracker, and reflects only the material inside the tracking volume; the expected contribution of the Phase-I pixel detector (hashed histogram) is provisionally used also for the Phase-II Tracker [1].



> Two sensors, with parallel strips, wire bonded to the

> 5 cooling contacts, 4 at the end of the spacers + 1

> CBC ASICs bump-bonded on the flexible hybrid

> 2 columns of 5 cm long strips with 90 µm pitch

> Single service hybrid carries low power GBT data

Module Design

same flexible-hybrid

> n-in-p Silicon bulk

Sensors

close to power components

 $> \sim 10 \times 10 \text{ cm}^2$ active area

link, and DC/DC power converter

CBC2 block diagram and layout

Chip logic block

> Cluster width discrimination (CWD), max. 3 adjacent strips.

> Offset correction (± 3 strips) & correlation logic (± 8 strips).

Read-out:

້ອັ 2000

^Ц 1800

1600

1400

1200

1000

800

600 400

200

M

\$ S0

• S1

- > Neighboring CBCs exchange data to identify boundary clusters.
- > The data flow separates L1 readout (DAQ) from Trigger (TRIG).

> Unsparsified binary readout data up to a 1MHz L1 rate per CBC.

The "stub" Concept

The first stage of stub finding starts with the analysis of adjacent strips, and wide cluster rejection on both sensors. For every valid cluster on the lower sensor the correlation logic will search for a valid cluster in the coincidence window on the upper sensor. Finding any

- indicates that a valid stub is present. > Stub data are sent out to the L1 trigger at each bunch
- crossing (40 MHz).
- > 5 to 10% (~125 stubs per bunch crossing) belong to primary tracks with $P_{\tau} > 2 \text{ GeV}$ [1].
- > Tracks are reconstructed by the L1 Track Finding system based on pattern recognition.

DESY-II Test Beam Setup and Measurements

e-

DESY-II electron/positron beam

> DESY operates an electron/positron test beam facility with three test beam lines [3].

> The beam has an energy of 1 GeV to 6 GeV with a spread of ~ 5%, a divergence of ~ 1 mrad, and a rate of O(1) kHz.

e+



| Pitch $[\mu m]$ | Thickness $[\mu m]$ | Length [mm] | strips # Vendor Bulk 254DUT CNM p-type 90 270Infineon n-type 80 50256REF 300

Measurements

> Positron beam, 2-4 GeV energy.

Event Reconstruction

The CBC2 chip provides binary read-out without information about the charge deposition on each strip, therefore, clusters are defined as group of neighboring strips with a signal.

The expected broadening of the clusters for steeper angles is visible in both sensors of the DUT.



Collimator Magnet Converter

γ | e+

Fiber



The concept of the two layers P_{T} -module of discrimination between high and low-momentum tracks identified as "pass" and "fail" stubs respectively.

The track P_{τ} discrimination is highly dependent on the position of the module in the tracker volume. To keep a uniform P_{τ} threshold across the tracker (~2 GeV), various sensor spacings (~1.6-4.0 mm) and coincidence window sizes (max. ±8 strips) must be implemented in different regions of the tracker.



Setup for data taking

> 2 x mini-2S modules, device under test (DUT) and reference (REF), see table and figure

> 2 x upstream and 2 x downstream trigger scintillators

> Trigger Logic Unit (TLU)

- > DUT mounted on xy&Ø stage, with REF fixed downstream.
- > Threshold scans ($6ke^{-}$ to $40ke^{-}$).

> Angular scans simulating magnetic field effect.



Beam profile distribution on the DUT Cluster width distribution as function sensors (S0 and S1) at normal incidence. of beam incident angle on the DUT.

At low rotational angles the cluster width is dominated (~90%) by single strips, while more clusters with 2 and 3 strips arises significantly at 22° and 32° respectively.



Fraction of clusters with different strip multiplicities as function of beam incident angle on the DUT.

Efficiency Studies vs. Threshold and Rotation Angle







Conclusions & Outlook

> A first test beam with mini 2S-module read out by CBC2 chip was performed with a positron beam successfully at DESY.

expected by performing an angular scan, obtaining

> A threshold scan per sensor and chip showed that